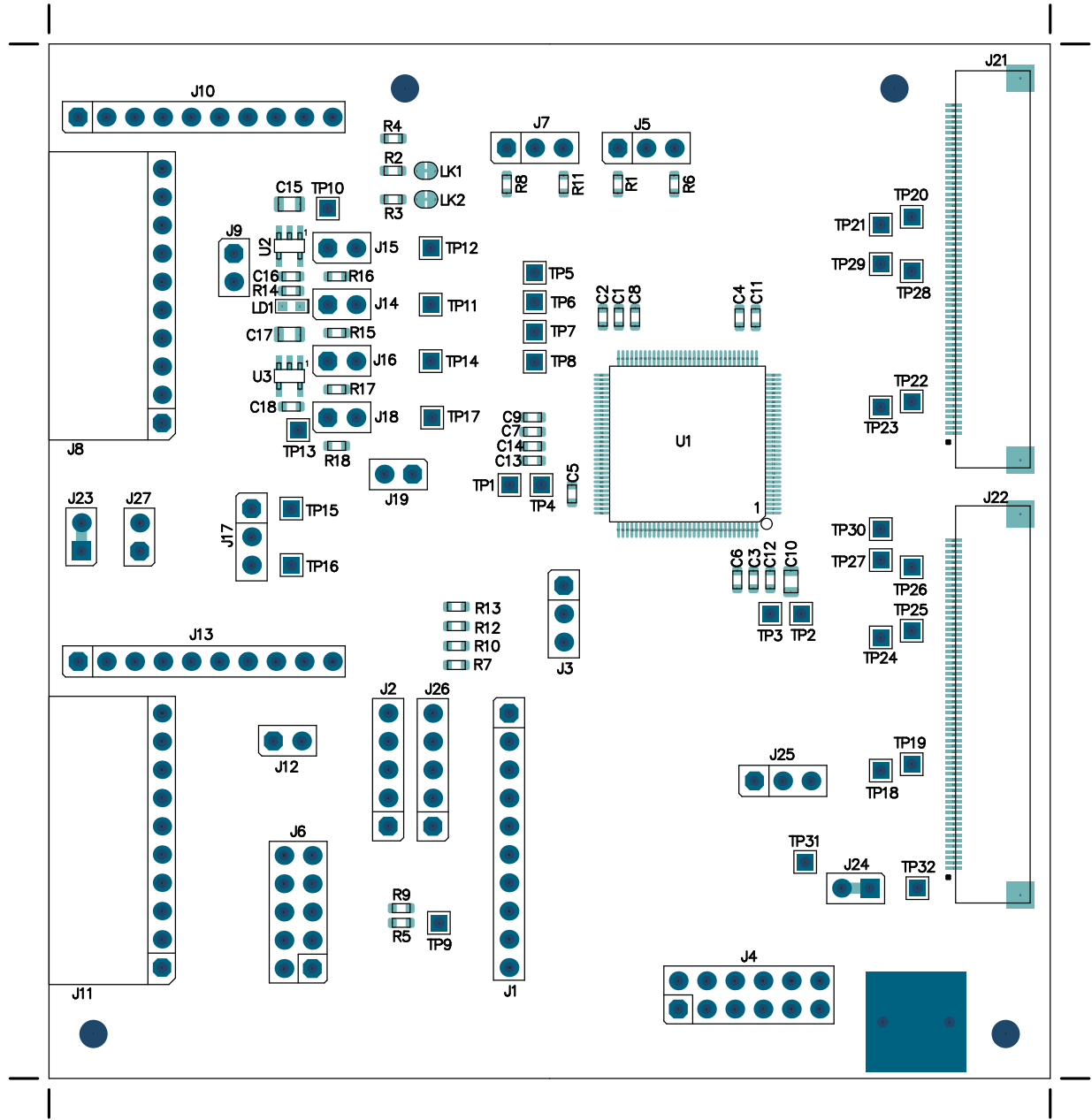




REV	ECO	Comments	Date
1	N/A	First Issue	4th Oct 2019
2	N/A	Updated to TCHABP-891	7th Dec 2020
3	N/A	Updated to TCHABP-900	17th Sept 2021

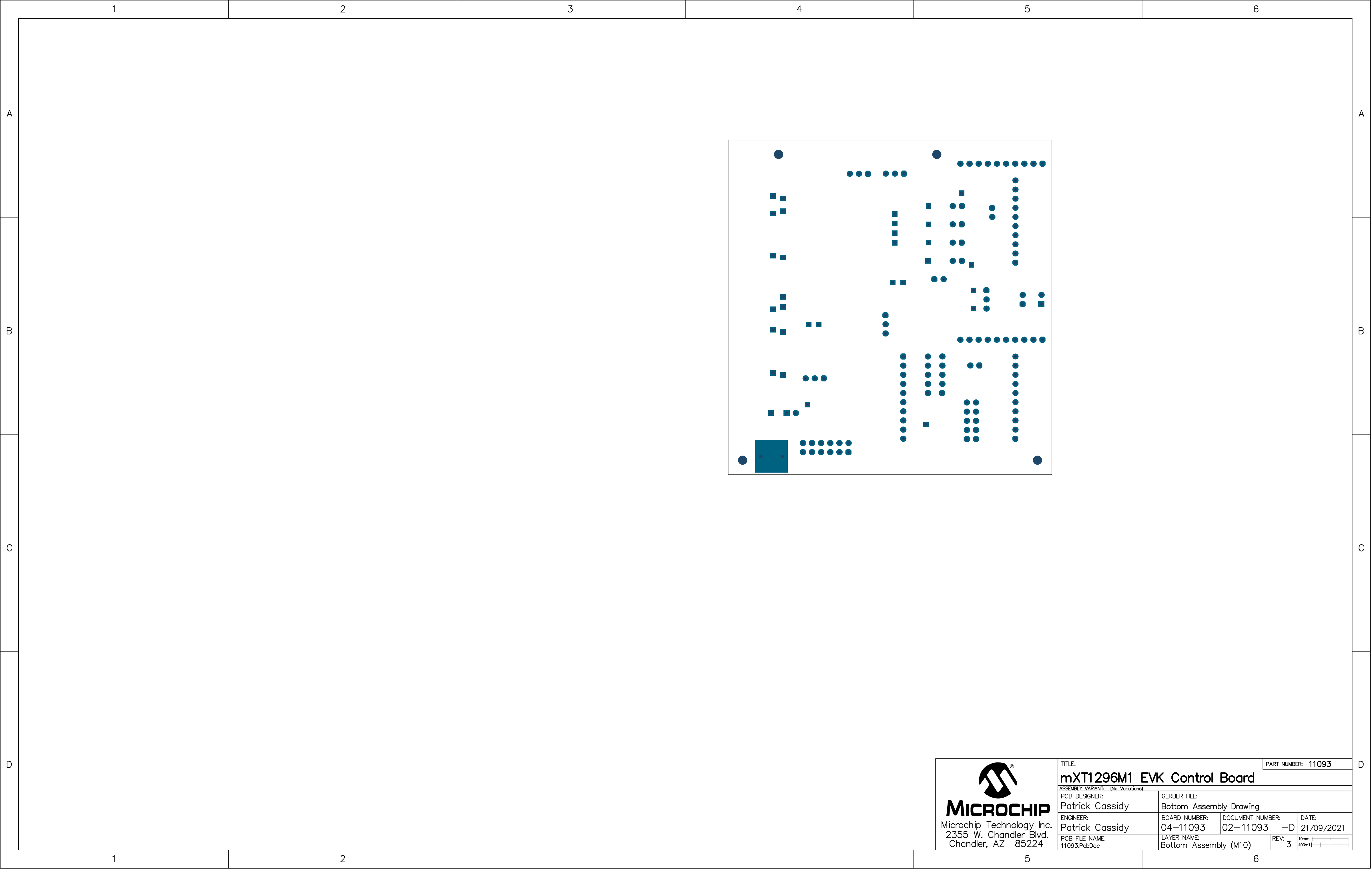


ASSEMBLY NOTES:

1. ALL COMPONENTS SHALL BE RoHS COMPLIANT.
2. ALL UNUSED THROUGH HOLE COMPONENT LOCATIONS SHALL BE FREE OF SOLDER.
3. ALL TEST POINT THROUGH HOLES (DENOTED TPxx) SHALL BE FREE OF SOLDER.
4. ALL COMPONENTS SHALL BE MOUNTED FLUSH TO THE BOARD, EXCEPT AS NOTED.
5. FINISHED BOARD SHALL BE FREE OF ALL RESIDUES.
6. ALL LEADS SHALL BE TRIMMED TO A MAXIMUM HEIGHT OF 2mm.
7. PLACE LABELS ON THE LOCATION INDICATED.



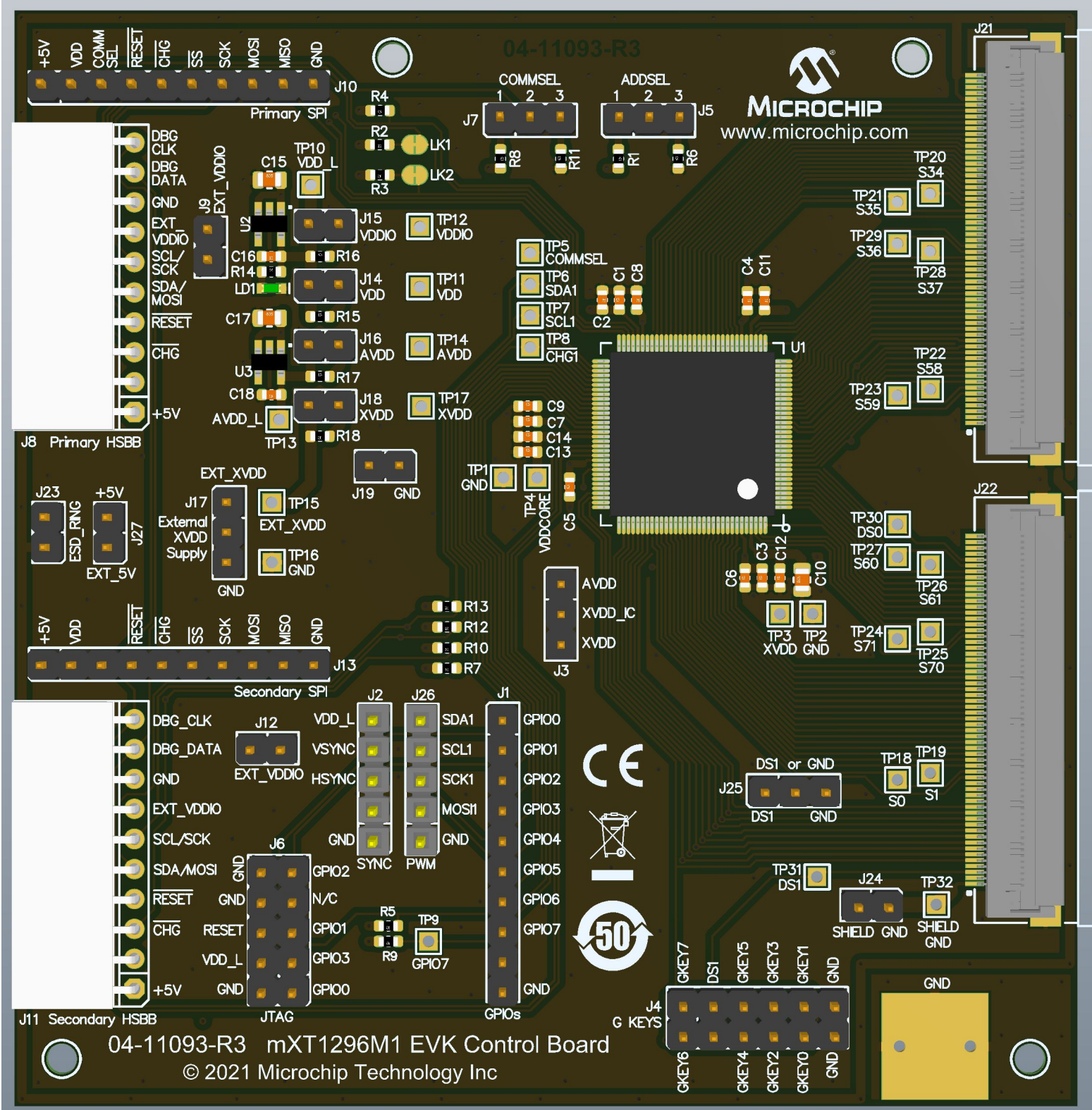
TITLE:		PART NUMBER: 11093	
mXT1296M1 EVK Control Board			
ASSEMBLY VARIANT: [No Variations]			
PCB DESIGNER: Patrick Cassidy		GERBER FILE: Top Assembly Drawing	
ENGINEER: Patrick Cassidy		BOARD NUMBER: 04—11093	DOCUMENT NUMBER: 02—11093 —D
PCB FILE NAME: 11093.PcbDoc		LAYER NAME: Top Assembly (M11)	DATE: 21/09/2021
		REV: 3	10mm:  400mi: 





**MICROCHIP**  
Microchip Technology Inc.  
2355 W. Chandler Blvd.  
Chandler, AZ 85224

TITLE:			PART NUMBER: 11093
mXT1296M1 EVK Control Board			
ASSEMBLY VARIANT: [No Variations]			
PCB DESIGNER: Patrick Cassidy		GERBER FILE: Bottom Assembly Drawing	
ENGINEER: Patrick Cassidy		BOARD NUMBER: 04-11093	DOCUMENT NUMBER: 02-11093 -D
PCB FILE NAME: 11093.PcbDoc		LAYER NAME: Bottom Assembly (M10)	REV: 3
		DATE: 21/09/2021	
		10mm 400mil	



04-11093-R3

